Part Numbering

Chip Monolithic Ceramic Capacitors

GR M 18 8 B1 1H 102 K A01 D

2 3 4 5 6 7 8 9 0 (Part Number)

●Product ID

2 Series		
Product ID	Code	Series
	J	Soft Termination Type
GR	М	Tin Plated Layer
GK	4	Only for Information Devices / Tip & Ring
	7	Only for Camera Flash Circuit
GQ	М	High Frequency for Flow/Reflow Soldering
GM	Α	Monolithic Microchip
GIVI	D	For Bonding
GN	М	Capacitor Array
	L	Low ESL Type
LL	R	Controlled ESR Low ESL Type
LL	Α	8-termination Low ESL Type
	М	10-termination Low ESL Type
GJ	М	High Frequency Low Loss Type
GA	2	For AC250V (r.m.s.)
GA	3	Safety Standard Certified Type

${\bf 3} \text{Dimensions (LXW)}$

Code	Dimensions (LXW)	EIA
02	0.4×0.2mm	01005
03	0.6×0.3mm	0201
05	0.5×0.5mm	0202
08	0.8×0.8mm	0303
0D	0.38×0.38mm	015015
ОМ	0.9×0.6mm	0302
15	1.0×0.5mm	0402
18	1.6×0.8mm	0603
1M	1.37×1.0mm	0504
21	2.0×1.25mm	0805
22	2.8×2.8mm	1111
31	3.2×1.6mm	1206
32	3.2×2.5mm	1210
42	4.5×2.0mm	1808
43	4.5×3.2mm	1812
52	5.7×2.8mm	2211
55	5.7×5.0mm	2220

♠Dimension (T) (Except GNM)

Code	Dimension (T)
2	0.2mm
3	0.3mm
5	0.5mm
6	0.6mm
7	0.7mm
8	0.8mm
9	0.85mm
Α	1.0mm
В	1.25mm
С	1.6mm
D	2.0mm
E	2.5mm
F	3.2mm
M	1.15mm
N	1.35mm
Q	1.5mm
R	1.8mm
S	2.8mm
Х	Depends on individual standards.

4Elements (**GNM** Only)

Code	Elements
2	2-elements
4	4-elements

Continued on the following page.



 $\begin{tabular}{|c|c|c|c|} \hline \end{tabular}$ Continued from the preceding page.

5Temperature Characteristics

Temperatur	e Characteristic C					
Code	Public STD (Code	Reference Temperature	Temperature Range	Capacitance Change or Temperature Coefficient	Operating Temperature Range
1X	SL *1	JIS	20°C	20 to 85°C	+350 to -1000ppm/°C	-55 to 125°C
2C	CH *1	JIS	20°C	20 to 125°C	0±60ppm/°C	-55 to 125°C
2P	PH *1	JIS	20°C	20 to 85°C	-150±60ppm/°C	-25 to 85°C
2R	RH *1	JIS	20°C	20 to 85°C	-220±60ppm/°C	-25 to 85°C
28	SH *1	JIS	20°C	20 to 85°C	-330±60ppm/°C	-25 to 85°C
2T	TH *1	JIS	20°C	20 to 85°C	-470±60ppm/°C	-25 to 85°C
3C	CJ *1	JIS	20°C	20 to 125°C	0±120ppm/°C	-55 to 125°C
3P	PJ *1	JIS	20°C	20 to 85°C	-150±120ppm/°C	-25 to 85°C
3R	RJ *1	JIS	20°C	20 to 85°C	-220±120ppm/°C	-25 to 85°C
38	SJ *1	JIS	20°C	20 to 85°C	-330±120ppm/°C	-25 to 85°C
3T	TJ *1	JIS	20°C	20 to 85°C	-470±120ppm/°C	-25 to 85°C
3U	UJ *1	JIS	20°C	20 to 85°C	-750±120ppm/°C	-25 to 85°C
4C	CK *1	JIS	20°C	20 to 125°C	0±250ppm/°C	-55 to 125°C
5C	C0G *1	EIA	25°C	25 to 125°C	0±30ppm/°C	-55 to 125°C
5G	X8G *1	EIA	25°C	25 to 150°C	0±30ppm/°C	-55 to 150°C
6C	C0H *1	EIA	25°C	25 to 125°C	0±60ppm/°C	-55 to 125°C
6P	P2H *1	EIA	25°C	25 to 85°C	-150±60ppm/°C	-55 to 125°C
6R	R2H *1	EIA	25°C	25 to 85°C	-220±60ppm/°C	-55 to 125°C
6S	S2H *1	EIA	25°C	25 to 85°C	-330±60ppm/°C	-55 to 125°C
6T	T2H *1	EIA	25°C	25 to 85°C	-470±60ppm/°C	-55 to 125°C
7U	U2J *1	EIA	25°C	25 to 125°C *6	-750±120ppm/°C	-55 to 125°C
B1	B *2	JIS	20°C	-25 to 85°C	±10%	-25 to 85°C
В3	В	JIS	20°C	-25 to 85°C	±10%	-25 to 85°C
C7	X7S	EIA	25°C	-55 to 125°C	±22%	-55 to 125°C
C8	X6S	EIA	25°C	-55 to 105°C	±22%	-55 to 105°C
D7	X7T	EIA	25°C	-55 to 125°C	+22, -33%	-55 to 125°C
D8	X6T	EIA	25°C	-55 to 105°C	+22, -33%	-55 to 105°C
E7	X7U	EIA	25°C	-55 to 125°C	+22, -56%	-55 to 125°C
F1	F *2	JIS	20°C	-25 to 85°C	+30, -80%	-25 to 85°C
F5	Y5V	EIA	25°C	-30 to 85°C	+22, -82%	-30 to 85°C
L8	X8L	*3	25°C	-55 to 150°C	+15, -40%	-55 to 150°C
R1	R *2	JIS	20°C	-55 to 125°C	±15%	-55 to 125°C
R3	R	JIS	20°C	-55 to 125°C	±15%	-55 to 125°C
R6	X5R	EIA	25°C	-55 to 85°C	±15%	-55 to 85°C
R7	X7R	EIA	25°C	-55 to 125°C	±15%	-55 to 125°C
R9	X8R	EIA	25°C	-55 to 150°C	±15%	-55 to 150°C
14/0			25.2	FE 1- 40500	±10% *4	FE / 4050C
W0	-	-	25°C	-55 to 125°C	+22, -33% *5	-55 to 125°C

^{*1} Please refer to table for Capacitance Change under reference temperature.
*2 Capacitance change is specified with 50% rated voltage applied.
*3 Murata Temperature Characteristic Code.

Continued on the following page.

Please check the MURATA home page (http://www.murata.com/) if you cannot find the part number in the catalog.



^{*4} Apply DC350V bias.

^{*5} No DC bias.

 $^{^*6}$ Rated Voltage 100Vdc max : 25 to 85°C

 $\begin{tabular}{|c|c|c|c|c|c|} \hline \end{tabular}$ Continued from the preceding page.

●Capacitance Change from each temperature

JIS Code

	Capacitance Change from 20°C (%)						
Murata Code	-55°C		−25°C		-10°C		
	Max.	Min.	Max.	Min.	Max.	Min.	
1X	-	-	-	-	-	-	
2C	0.82	-0.45	0.49	-0.27	0.33	-0.18	
2P		-	1.32	0.41	0.88	0.27	
2R		-	1.70	0.72	1.13	0.48	
28		-	2.30	1.22	1.54	0.81	
2T	-	-	3.07	1.85	2.05	1.23	
3C	1.37	-0.90	0.82	-0.54	0.55	-0.36	
3P	-	_	1.65	0.14	1.10	0.09	
3R		_	2.03	0.45	1.35	0.30	
38	-	_	2.63	0.95	1.76	0.63	
3T	-	-	3.40	1.58	2.27	1.05	
3U	-	_	4.94	2.84	3.29	1.89	
4C	2.56	-1.88	1.54	-1.13	1.02	-0.75	

EIA Code

			Capacitance Char	nge from 25°C (%)		
Murata Code	-5	5°C	-30)°C	-10)°C
	Max.	Min.	Max.	Min.	Max.	Min.
5C/5G	0.58	-0.24	0.40	-0.17	0.25	-0.11
6C	0.87	-0.48	0.59	-0.33	0.38	-0.21
6P	2.33	0.72	1.61	0.50	1.02	0.32
6R	3.02	1.28	2.08	0.88	1.32	0.56
6S	4.09	2.16	2.81	1.49	1.79	0.95
6T	5.46	3.28	3.75	2.26	2.39	1.44
7U	8.78	5.04	6.04	3.47	3.84	2.21
-		1				1

6Rated Voltage

Code	Rated Voltage
0E	DC2.5V
0G	DC4V
0J	DC6.3V
1A	DC10V
1C	DC16V
1E	DC25V
YA	DC35V
1H	DC50V
2A	DC100V
2D	DC200V
2E	DC250V
YD	DC300V
2H	DC500V
2J	DC630V
3A	DC1kV
3D	DC2kV
3F	DC3.15kV
ВВ	DC350V (for Camera Flash Circuit)
E2	AC250V
GC	X1/Y2; AC250V (Safety Standard Certified Type GC)
GF	Y2, X1/Y2; AC250V (Safety Standard Certified Type GF)
GD	Y3; AC250V (Safety Standard Certified Type GD)
GB	X2; AC250V (Safety Standard Certified Type GB)

⑦Capacitance

Expressed by three-digit alphanumerics. The unit is picofarad (pF). The first and second figures are significant digits, and the third figure expresses the number of zeros which follow the two numbers. If there is a decimal point, it is expressed by the capital letter "R." In this case, all figures are significant digits.

.)	Code	Capacitance
	R50	0.5pF
	1R0	1.0pF
	100	10pF
	103	10000pF

Continued on the following page.

Please check the MURATA home page (http://www.murata.com/) if you cannot find the part number in the catalog.



 $\begin{tabular}{|c|c|c|c|c|c|} \hline \end{tabular}$ Continued from the preceding page.

8 Capacitance Tolerance

Code	Capacitance Tolerance	TC	Series	Ca	pacitance Step
W	±0.05pF	СΔ	GRM/GJM	≦9.9pF	0.1pF
			GRM/GJM	≦9.9pF	0.1pF
В	±0.1pF	СΔ	GQM	≦1pF	0.1pF
			GQW	1.1 to 9.9pF	1pF Step and E24 Serie
		СΔ	GRM/GJM	≦9.9pF	0.1pF
С	±0.25pF	except CΔ	GRM	≦5pF	* 1pF
C	±0.25με	СΔ	GQM	≦1pF	0.1pF
		CΔ	GQW	1.1 to 9.9pF	1pF Step and E24 Serie
		СΔ	GRM/GJM	5.1 to 9.9pF	0.1pF
D	±0.5pF	except CΔ	GRM	5.1 to 9.9pF	* 1pF
		СΔ	GQM 5	5.1 to 9.9pF	1pF Step and E24 Serie
G	±2%	СΔ	GJM	≥10pF	E12 Series
G	±270	СΔ	GQM	≥10pF	E24 Series
J	±5%	CΔ, SL, U2J	GRM/GA3	≥10pF	E12 Series
J	±3 %	СΔ	GQM/GJM	≥10pF	E24 Series
		B, R, X7R, X5R, ZLM	GRJ/GRM/GR7/GA3		E6 Series
K	±10%	COG	GNM		E6 Series
		B, R, X7R, X5R, ZLM	GR4, GMD		E12 Series
		B, R, X7R, X7S	GRM/GMA		E6 Series
М	±20%	X5R, X7R, X7S	GNM		E3 Series
IVI	±20%	X7R	GR4, GMD GRM/GMA		E3 Series
		X5R, X7R, X7S, X6S	LLL/LLR/LLA/LLM		E3 Series
Z	+80%, -20%	F, Y5V	GRM		E3 Series
R		Depend	s on individual standards.	,	

^{*} E24 series is also available.

Individual Specification Code (Except LLR)

Expressed by three figures.

9ESR (**LLR** Only)

Code	ESR
E01	100mΩ
E03	220mΩ
E05	470mΩ
E07	1000mΩ

Packaging

Code	Packaging			
L	ø180mm Embossed Taping			
D	ø180mm Paper Taping			
E	ø180mm Paper Taping (LLL15)			
K	ø330mm Embossed Taping			
J	ø330mm Paper Taping			
F	ø330mm Paper Taping (LLL15)			
В	Bulk			
С	Bulk Case			
Т	Bulk Tray			

Please check the MURATA home page (http://www.murata.com/) if you cannot find the part number in the catalog.



0.3

Product Information

Chip Monolithic Ceramic Capacitors (Medium Voltage)

1.5 +0, -0.3

For Information Devices GR4 Series

■ Features

- 1. These items are designed specifically for telecommunications devices (IEEE802.3) in Ethernet LAN and primary-secondary coupling for DC-DC converters.
- 2. A new monolithic structure for small, high capacitance capable of operating at high voltage levels
- 3. Sn-plated external electrodes realize good solderability.
- 4. Only for reflow soldering

■ Applications

- 1. Ideal for use on telecommunications devices in Ethernet LAN
- 2. Ideal for use as primary-secondary coupling for DC-DC converters

Do not use these products in any Automotive Power train or Safety equipment including Battery charger for Electric Vehicles and Plug-in Hybrid. Only Murata products clearly stipulated as "for Automotive use" can be used for automobile applications such as Power train and Safety equipment.

			L	W	2.5				
Dont Number		Dime	ensions (mm)						
Part Number	L	W	T	e min.	g min.				
GR442Q	4.5 ±0.3	2.0 ±0.2	1.5 +0, -0.3						
GR443D	45.04	22102	2.0 +0, -0.3]	2.5				

 3.2 ± 0.3

4.5 ±0.4

5.7 ±0.4 5.0 ±0.4

GR443Q

GR455D

Part Number	Rated Voltage (V)	TC Code (Standard)	Capacitance (pF)	Length L (mm)	Width W (mm)	Thickness T (mm)	Electrode g min. (mm)	Electrode e (mm)
GR442QR73D101KW01L	DC2000	X7R (EIA)	100 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D121KW01L	DC2000	X7R (EIA)	120 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D151KW01L	DC2000	X7R (EIA)	150 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D181KW01L	DC2000	X7R (EIA)	180 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D221KW01L	DC2000	X7R (EIA)	220 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D271KW01L	DC2000	X7R (EIA)	270 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D331KW01L	DC2000	X7R (EIA)	330 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D391KW01L	DC2000	X7R (EIA)	390 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D471KW01L	DC2000	X7R (EIA)	470 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D561KW01L	DC2000	X7R (EIA)	560 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D681KW01L	DC2000	X7R (EIA)	680 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D821KW01L	DC2000	X7R (EIA)	820 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D102KW01L	DC2000	X7R (EIA)	1000 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D122KW01L	DC2000	X7R (EIA)	1200 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D152KW01L	DC2000	X7R (EIA)	1500 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR443QR73D182KW01L	DC2000	X7R (EIA)	1800 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443QR73D222KW01L	DC2000	X7R (EIA)	2200 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443QR73D272KW01L	DC2000	X7R (EIA)	2700 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443QR73D332KW01L	DC2000	X7R (EIA)	3300 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443QR73D392KW01L	DC2000	X7R (EIA)	3900 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443DR73D472KW01L	DC2000	X7R (EIA)	4700 ±10%	4.5	3.2	2.0	2.5	0.3 min.
GR455DR73D103KW01L	DC2000	X7R (EIA)	10000 ±10%	5.7	5.0	2.0	3.2	0.3 min.

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GR4 Series Specifications and Test Methods

No.	Ite	m	Specifications		Test Method			
1	Operating Temperatu	re Range	−55 to +125°C		_			
2	Appearan	ce	No defects or abnormalities	Visual inspection				
3	Dimension	ns	Within the specified dimensions	Using calipers and	micrometers			
4	Dielectric	Strength	No defects or abnormalities	No failure should be observed when voltage in the table is applied between the terminations, provided the charge/discharge current is less than 50mA. Rated Voltage Test Voltage Time 120% of the rated voltage 60±1 sec. AC1500V(r.m.s.) 60±1 sec.				
5	Pulse Volt	tage	No self healing breakdowns or flash-overs have taken place in the capacitor.	10 impulses of alternating polarity are subjected. (5 impulses for each polarity) The interval between impulses is 60 sec. Applied Pulse: 1.2/50µs Applied Voltage: 2.5kVo-p				
6	Insulation R (I.R.)	Resistance	More than $6{,}000M\Omega$	The insulation resistand within 60±5 set	tance should be measured w c. of charging.	ith DC500±50V		
7	Capacitar	nce	Within the specified tolerance	The capacitance/D	F. should be measured at a	frequency of		
8		Dissipation Factor (D.F.) 0.025 max.			Itage of AC1±0.2V(r.m.s.)	rrequericy or		
9	Capacitance 9 Temperature Characteristics		Cap. Change within ±15% (Temp. Range: −55 to +125°C)	The capacitance measurement should be made at each step specified in the Table. Step Temperature (°C) 1 25±2 2 Min. Operating Temp.±3 3 25±2 4 Max. Operating Temp.±2 5 25±2 • Pretreatment Perform a heat treatment at 150 ⁺⁰ / ₋₁₀ °C for 60±5 min. and then let sit for 24±2 hrs. at room condition.*				
10	Adhesive Strength of Termination		No removal of the terminations or other defect should occur.	Solder the capacitor to the testing jig (glass epoxy board) show in Fig. 1. Then apply 10N force in the direction of the arrow. The soldering should be done using the reflow method and should be conducted with care so that the soldering is uniform and free of defects such as heat shock. 10N, 10±1s Glass Epoxy Board Fig. 1				
		Appearance	No defects or abnormalities	Solder the capacito	r to the test jig (glass epoxy b	ooard).		
	Vibration Resistance D.F.	Capacitance	Within the specified tolerance	The capacitor should be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied				
11				uniformly between the approximate limits of 10 and 55Hz. Th frequency range, from 10 to 55Hz and return to 10Hz, should traversed in approximately 1 min. This motion should be appli for a period of 2 hrs. in each of 3 mutually perpendicular directions (total of 6 hrs.). Solder resist Glass Epoxy Board				

 $^{^{\}star}$ "Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Continued on the following page.



Safety Standard Certified GA3 Series

Only for Applications

For General Purpose
GR4 Series
GRM/GRJ Series

Product Information

GR4 Series Specifications and Test Methods

No.	Ite	Item Specifications				Test Method					
12 Deflect	Deflection	1	No marking defects					Solder the capacitor to the testing jig (glass epoxy board) show in Fig. 2. Then apply a force in the direction shown in Fig. 3. The soldering should be done using the reflow method and should be conducted with care so that the soldering is uniform and free of defects such as heat shock. 20 50 Pressurizing speed: 1.0mm/s Pressurize Pressurize Flexure=1			
			4.5×2.0	3.5	7.0	2.4			Capacitance meter 45 45	(in mm)	
			4.5×3.2 5.7×5.0	3.5 4.5	7.0 8.0	3.7 5.6	1.0		Fig. 3		
13		Solderability of Termination 75% of the terminations are to be soldered evenly and continuously.					Immerse the capacitor in a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion). Immerse in solder solution for 2±0.5 sec. Immersing speed: 25±2.5mm/s Temp. of solder: 245±5°C Lead Free Solder (Sn-3.0Ag-0.5Cu) 235±5°C H60A or H63A Eutectic Solder				
		Appearance	No marking defe	ects					apacitor as in table.		
		Capacitance Change	Within ±10% 0.025 max.					Immerse the capacitor in solder solution at 260±5°C for 10±1 sec. Let sit at room condition* for 24±2 hrs., then measure. •Immersing speed: 25±2.5mm/s			
		D.F.						•Pretreatmen	nt		
14	Resistance to Soldering L Heat	I.R.	More than 1,000M Ω					Perform a heat treatment at 150^{\pm} .0°C for 60 ± 5 min. and the let sit for 24 ± 2 hrs. at room condition.*			
		Dielectric						*Preheating			
		Strength	In accordance v	vith item No	0.4			Step 1 2	Temperature 100 to 120℃ 170 to 200℃	Time 1 min. 1 min.	
		Appearance	No marking defects					Fix the capaci	itor to the supporting jig (glass	epoxy board) show	
	Capacitance Change		Within ±15%					in Fig. 4.	cycles according to the 4 heat		
		D.F.	0.05 max.					Let sit for 24±2 hrs. at room condition,* then measure.			
		I.R.	More than 3,000	ΟΜΩ				Step	Temperature (℃)	Time (min.)	
								1	Min. Operating Temp.±3 Room Temp.	30±3 2 to 3	
	Temperature Cycle							3	Max. Operating Temp.±2	30±3	
		Dielectric Strength	In accordance v	vith item No	o.4				eat treatment at 150 [±] −1 ⁰ °C for ±2 hrs. at room condition.*	2 to 3 60±5 min. and ther	
									Solder Glass Epoxy Board Fig. 4	resist	
		Appearance	No marking defects				-				
	Humidity	Capacitance Change	Within ±15%					for 500 ⁺²⁴ ohr	itor sit at 40±2°C and relative h s. let sit for 24±2 hrs. at room co		
			1					i iveniove and	iol sil ioi 2+12 iiis. al iuuiii Cl	andiuoit. UICII	
6	(Steady State)	D.F.	0.05 max.					measure. •Pretreatmen		,	

^{* &}quot;Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Dielectric

Strength

In accordance with item No.4

Continued on the following page.

Perform a heat treatment at 150[±]₁8°C for 60±5 min. and then let sit for 24±2 hrs. at room condition.*



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1210J2K00102KXT 1210J5000103KXT 1210J5000223KXT D55342E07B379BR-TR D55342E07B523DR-T/R 1812J1K00103KXT

1812J1K00473KXT 1812J2K00680JCT 1812J4K00102MXT 1812J5000102JCT 1812J5000103JCT 1812J5000682JCT NIN-FB391JTRF

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CGA2B2C0G1H2R2C CGA2B2C0G1H3R3C CGA2B2C0G1H680J CGA2B2C0G1H6R8D CGA2B2X8R1H221K CGA2B2X8R1H472K

CGA3E1X7R1C474K